



Data Sheet

Customer:	
Part No:	CL-SP1606DBW-02
Sample No:	
Description:	1606 SMD White Color
Item No:	

Customer						
Check Inspection Approval Date						





Features

- _1.7mmX0.6mm SMT LED, 1.1mm THICKNESS.
- LOW POWER CONSUMPTION.
- _WIDE VIEWING ANGLE.
- _IDEAL FOR BACKLIGHT AND INDICATOR.
- _VARIOUS COLORS AND LENS TYPES AVAILABLE.
- _PACKAGE: 4000 PCS / REEL.
- _RoHS COMPLIANT.



Description

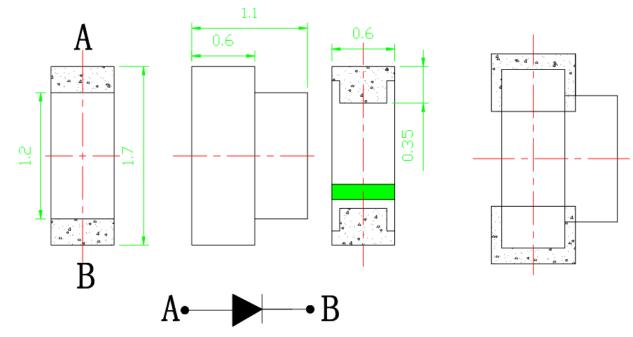
The Yellow source color devices are made with

Gallium

Arsenide Phosphide on Gallium Phosphide

Yellow Light

Package Dimensions



Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.1 (0.004\mbox{"})$ unless otherwise noted.
- 3. Specifications are subject to change without notice.





Selection Guide

			lv (mcd) @ 20mA		Viewing
Part No.	Dice	Lens Type			Angle
			Min.	MAX.	2 θ 1/2
CL-SP1606DBW-02	White (GaN)	Yellow Diffused	500	1000	120

Note:

1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.

Electrical / Optical Characteristics at Ta=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λD	Dominant Wavelength	White	7500K	12500K	nm	IF=20mA
Δλ1/2	Spectral Line Half-width	White			nm	IF=20mA
С	Capacitance	White			pF	VF=0V;f=1MHz
VF	Forward Voltage	White	2.8	3.4	٧	IF=20mA
IR	Reverse Curren	White		2	uA	VR = 5V

Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm

2. Luminous Intensity: +/-15%

3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters

Absolute Maximum Ratings at Ta=25°C

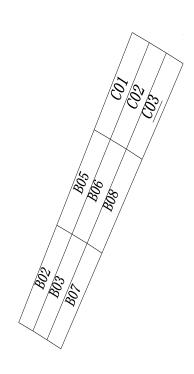
Parameter	White	Units
Power dissipation	135	mW
DC Forward Current	30	mA
Peak Forward Current [1]	140	mA
Reverse Voltage	5	V
Operating/Storage Temperature	-40°C To +85°C	·

Note:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.



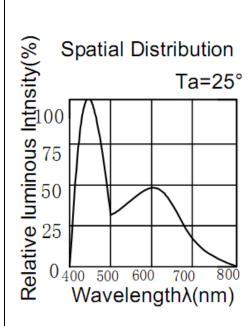


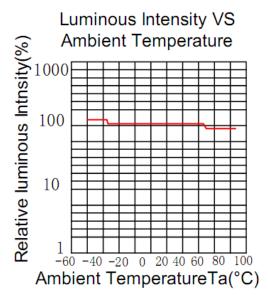


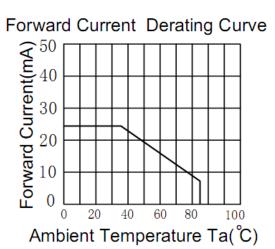
色区 坐标	X1	Y1	X2	Y2	Х3	Y 3	X4	Y4
B02	0. 2729	0. 2682	0. 2699	0. 2697	0. 2780	0. 2866	0. 2812	0. 2850
В03	0. 2759	0. 2667	0. 2729	0. 2682	0. 2812	0. 2850	0. 2845	0. 2834
В07	0. 2789	0. 2651	0. 2759	0. 2667	0. 2845	0. 2834	0. 2876	0. 2817
В05	0. 2812	0. 2850	0. 2780	0. 2866	0. 2860	0.3031	0. 2894	0. 3015
В06	0. 2845	0. 2834	0. 2812	0.2850	0. 2894	0.3015	0. 2928	0. 2998
В08	0. 2876	0. 2817	0. 2845	0. 2834	0. 2928	0. 2998	0. 2962	0. 2980
C01	0. 2894	0.3015	0. 2860	0.3031	0. 2941	0.3200	0. 2977	0. 3182
C02	0. 2928	0. 2998	0. 2894	0.3015	0. 2977	0. 3182	0. 3013	0. 3164
C03	0. 2962	0. 2980	0. 2928	0. 2998	0.3013	0.3164	0.3049	0. 3146

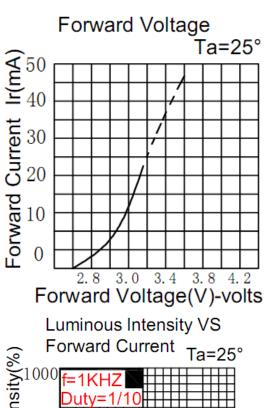


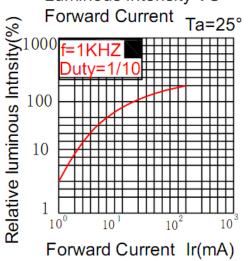


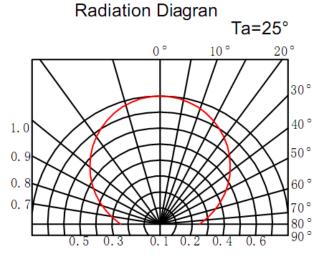
















RELIABILITY

Test Items and Results

10	st Items and Rest	1113				
NO.	Test Item	Reference Standard	Test Condition	(Hours/ Cycles)	Sample	Number of Damaged
1	Temperature Cycle	JEITA ED-4701	-40°C ~25°C ~100°C ~ 25°C 30 min 5 min 30 min 5 min	100 Cycles	50	0/50
2	Thermal Shock	MIL-STD-202G	-40℃~100℃ 15 分钟 15 分钟	500 Cycles	50	0/50
3	High Temperature Storage	JEITA ED-4701 200 201	Ta=100°C	1000 Hours	50	0/50
4	Low Temperature Sotrage	JEITA ED-4701 200 201	Ta=-40°C	1000 Hours	50	0/50
5	Room Temperature Life Test		$T_a=25\pm5$ °C $I_F=20mA$	1000 Hours	50	0/50
6	High Temperature High Humidity Life Test		Ta=60°C RH=85% I _F =20mA	1000 Hours	50	0/50
7	Solderability (Reflow Soldering)	JEITA ED-4701 300 303	$T_{\text{sol}}=235^{\circ}\text{C}\pm5^{\circ}\text{C}$,5 sec (Using Flux, Lead Solder)	1 time, 5 sec	10	0/10
8	Resistance to Soldering Heat (Reflow Soldering)	JEITA ED-4701 300 301	T _{sol} =260°C,10 sec Pre Treatment: 35°C 95%RH 96 Hrs	2 time, 10 sec	10	0/10

The above test items such as differences or special customer specific requirements according to the actual situation in accordance with the requirements of customers to try the requirements with the customer, the customer is not required by our test standard test. Different products using different current test.





5. Cautions

(1) Soldering Conditions

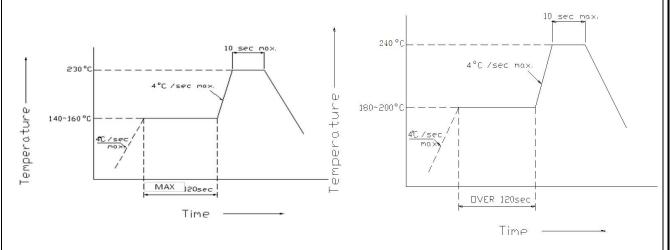
Number of reflow process shall be less than 2 times and cooling process to normal temperature is required between first and Second soldering process.

(Recommended soldering conditions)

回流	焊接 Reflow Solder:	手工焊接		
预热温度 Pre-heat	有铅 Lead Solder	无铅 Lead-free Solder	温度 Temperature 焊接时间 Soldering	350° C Max. 3 sec. Max.
预热时间 Pre-heat time 峰值温度 Peak temperature 焊接时间 Soldering	140 ~ 160° C 120 sec. Max. 230° C Max. 10 sec. Max. 参考下图	180 ~ 200° C 120 sec. Max. 240° C Max. 10 sec. Max.	time	(one time only)
time 条件Condition				

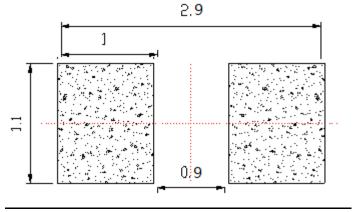
(Lead Solder)

(Lead-Free Solder)



Recommended Soldering Pattern

(Units: mm)







(2) Static Electricity

It is recommended that a wrist band or an anti-electrostatic glove be used when handling the LEDs.

All devices, equipment and machinery must be properly grounded.

Damaged LEDs will show some unusual characteristics such as the forward voltage becomes lower, or the LEDs do not light at the low current. Criteria: (VF > 2.0V at IF = 0.5mA)

(3) Moisture Proof Package

It is recommended that moisture proof package be used .

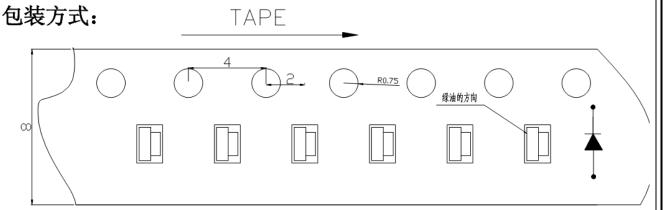
- (4) Cautions:
 - 4.1. Please check if there is air leak before opening the package, if so, please return the goods back to take drying process for later using.
 - 4.2 Products can be used within 15days after packaging, after that, they must be:
 - 4.2.1 Soldered within 24 hrs
 - 4.2.2 Used in the condition: 30°C within and 60%RH below
 - 4.2.3 Stored in 30%RH for moisture below.
 - 4.3. Products cannot be used for and over 15days after being packaged unless opening the package and take drying our process in 85°C/6H .
 - 4.4. Products not be used for or over 60days after being packaged please return back to take drying out and packaging process for forward using.
 - 4.5. Products not be used after opening the package need to be dried out for $85\,^{\circ}\text{C}/6\text{H}$





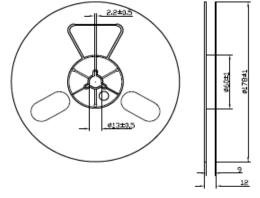
PACKAGING

The LEDs are packed in cardboard boxes after taping.

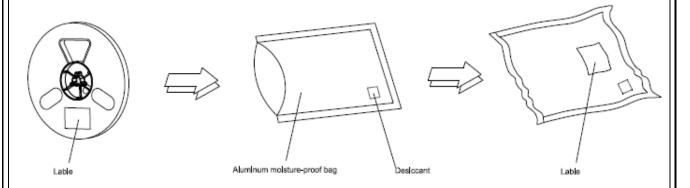


Package:4000PCS/ree1

Reel Dimensions



Moisture Resistant Packaging



Note:The tolerances unless mentioned is ±0.1mm,Unit:mm